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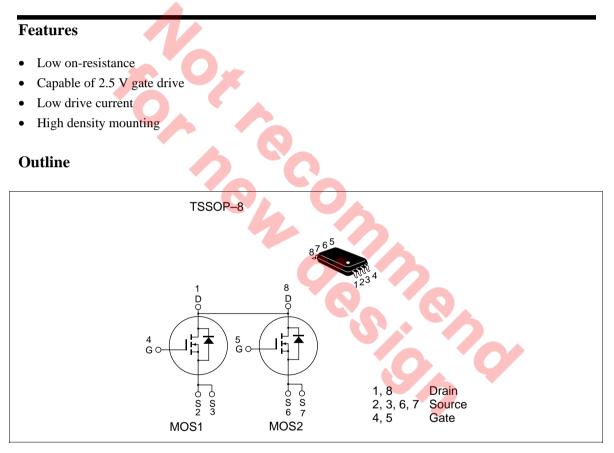
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Silicon N Channel Power MOS FET High Speed Power Switching



ADE-208-669F (Z) 7th. Edition Feb. 1999



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	28	V
Gate to source voltage	V _{GSS}	± 12	V
Drain current	I _D	5.0	Α
Drain peak current	Note1 D(pulse)	40	A
Body-drain diode reverse drain current	I _{DR}	5.0	A
Channel dissipation	Pch Note2	1.0	W
Channel dissipation	Pch Note3	1.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	– 55 to + 150	°C

Note: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. 1 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW ≤ 10 s
- 3. 2 Drive operation ; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW ≤ 10 s

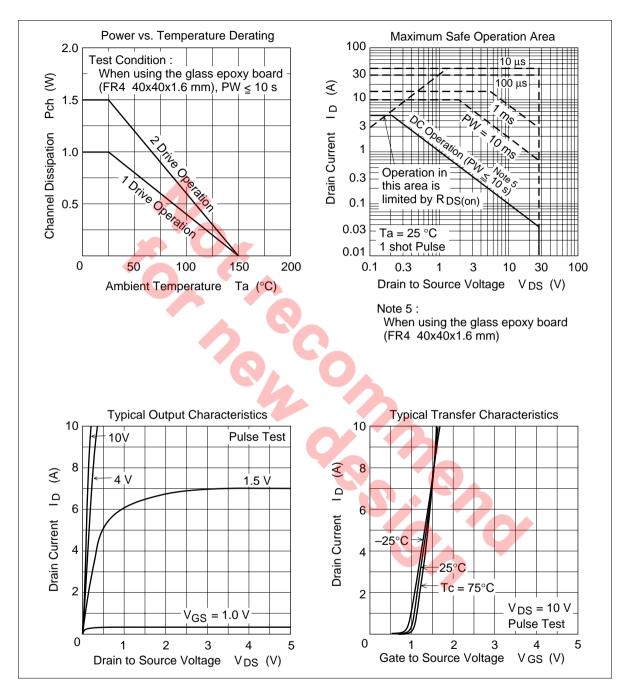
Symbol Min **Test Conditions** Item Тур Max Unit Drain to source breakdown voltage V(BRIDSS) 28 V $I_{D} = 10 \text{mA}, V_{CS} = 0$ $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$ Gate to source leak current I_{GSS} - ± 0.1 μΑ Zero gate voltege drain current 1 $V_{DS} = 28 \text{ V}, V_{GS} = 0$ μΑ I_{DSS} 1.4 V $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$ Gate to source cutoff voltage V_{GS(off)} 0.4 $I_{D} = 3 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note4}}$ Static drain to source on state 0.027 0.034 Ω R_{DS(on)} $I_{D} = 3 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note4}}$ resistance 0.037 0.044 Ω R_{DS(on)} ____ $I_{D} = 3 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$ Forward transfer admittance 7 11 S y_{fs} Ciss pF $V_{DS} = 10 V$ Input capacitance 510 ____ pF $V_{GS} = 0$ Output capacitance Coss ____ 190 Reverse transfer capacitance Crss 140 pF f = 1 MHz____ V_{DD} = 10 V Total gate charge Qg 8.5 nc $V_{GS} = 4 V$ Gate to source charge Qgs 4.5 nc Gate to drain charge Qgd 4 nc $I_{D} = 5 A$ Turn-on delay time 14 $V_{GS} = 4 V, I_{D} = 3 A$ $\mathbf{t}_{\mathrm{d(on)}}$ ns Rise time $V_{DD} \cong 10 \text{ V}$ t, 120 ns Turn-off delay time 85 ns t_{d(off)} Fall time t, ___ 120 ____ ns V_{DF} $IF = 5.0 A, V_{GS} = 0^{Note4}$ Body-drain diode forward voltage 0.85 1.1 V $IF = 5.0 A, V_{GS} = 0$ Body-drain diode reverse 40 t_{rr} ns recovery time diF/ dt = 20 A/ μ s

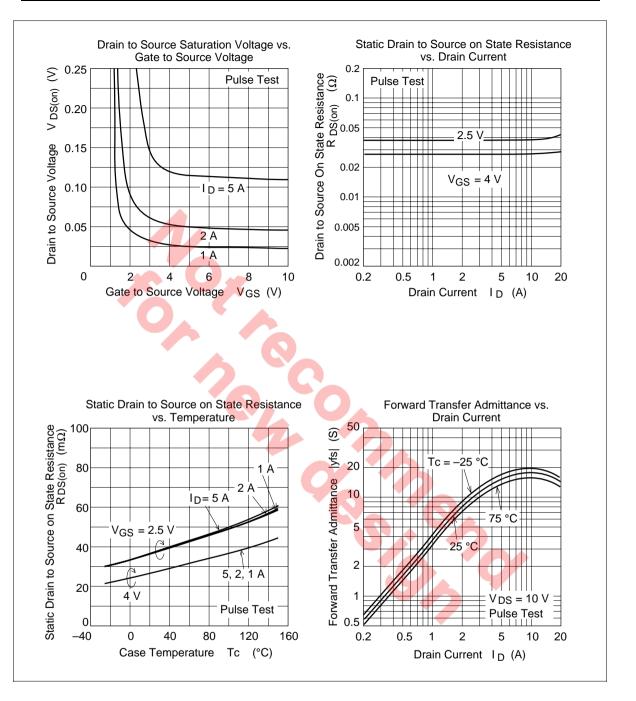
Electrical Characteristics (Ta = 25°C)

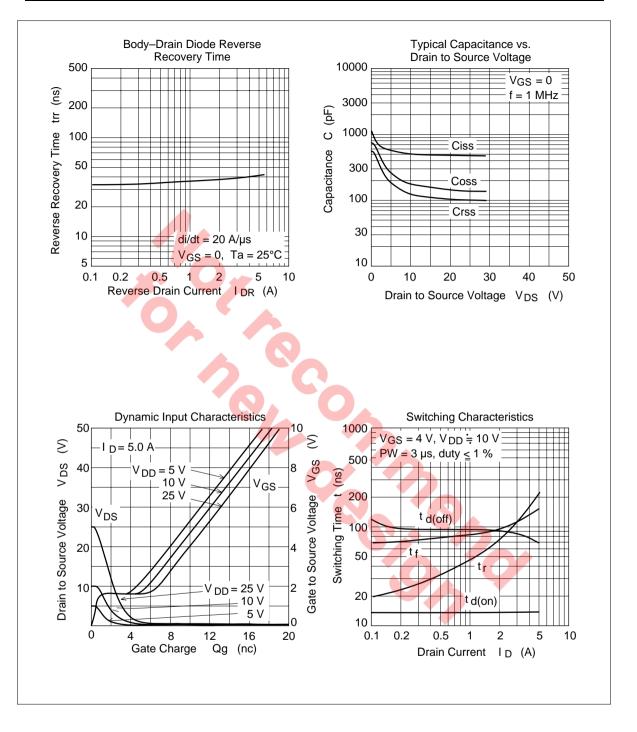
Note: 4. Pulse test

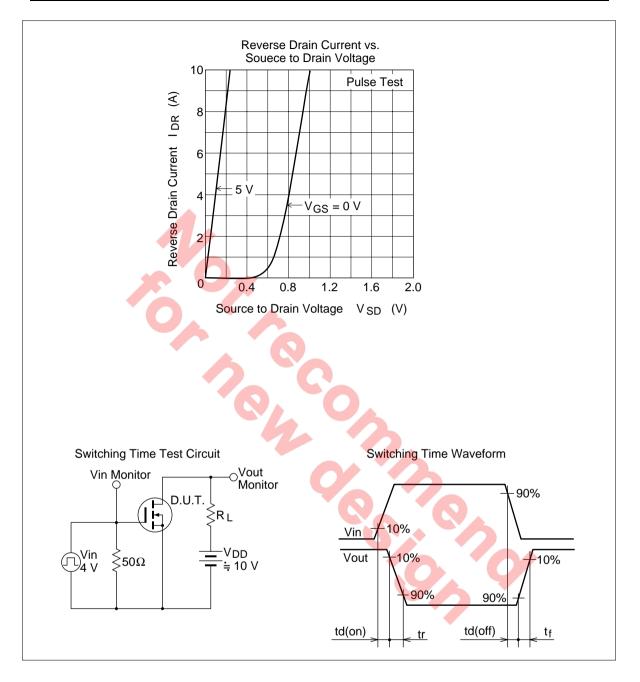
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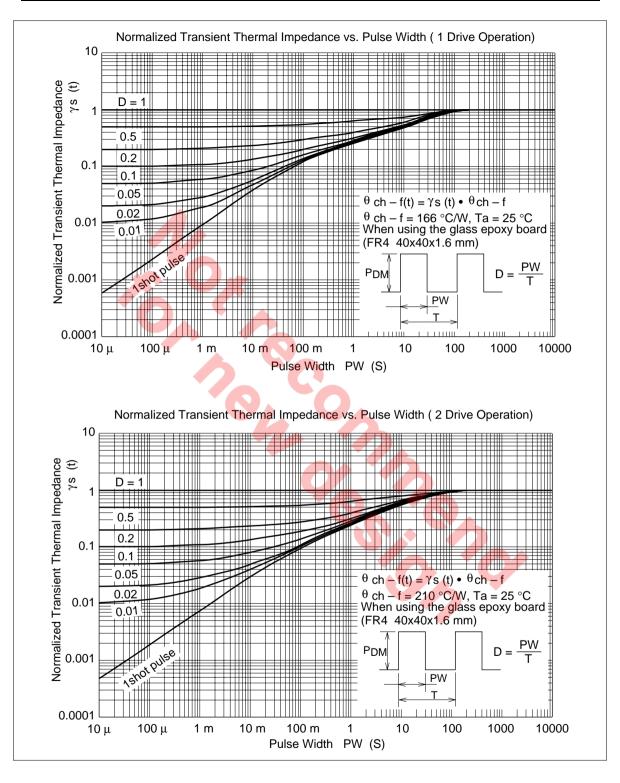
Main Characteristics





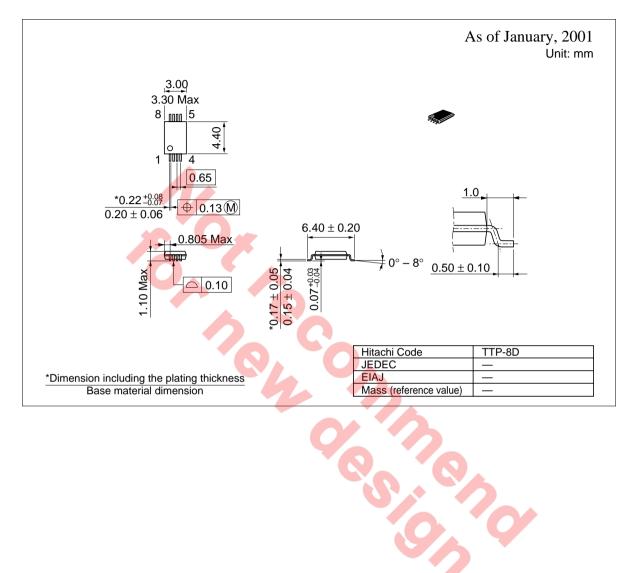






Renesas

Package Dimensions





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